

Home

» Applications

» ASIC & Foundry

» Products

» ASSPs

» Diodes

Semiconductor & Storage Products Company

» Contact Us ● Part Number Search C Keyword Search C Contact Us Part Number Search C Contact Us Part Number Search Part Number

About Us

Main Menu

» Home Page

Products

Home, Memory, NAND Flash, MLC NAND, e+MMC™

e•MMC™

The in

Displays & Devices
 Driver IC

- » General Purpose Linear ICs
- » General Purpose Logic ICs
- » Memory
- » Emb. NAND Flash
- » SLC NAND
- » SLC NAND Small Block
- » SLC NAND Large Block
- » SLC NAND Large Capacity
- » SLC NAND Toggle Interface
- » BENAND™
- » MLC NAND Flash
- » e•MMC™
- » SmartNAND™
- » MCP Memory
- Solutions

 » FlashAir™ Wireless

» Content Storage

- LAN SD Card

 » Cards & USB Sticks
- for Consumers
- » Microcontroller
- » Optical Semiconductor Devices
- » Radio-Frequency Devices
- » Sensors
- » Solid State Drive (SSD)
- » <u>Transistors</u>
- » Wireless Systems

» About Toshiba Electronics Europe

Search

» Support

» Search Datasheets on Toshiba Semicon, site

» Site Search

»

The interface of

MMC™ is compliant with Version 4.4/4.41 of the JEDEC

MMC™ standard for high-speed memory cards. Users can easily use

MMC™ in various products as an embedded MMC memory device (

MMC™ compliant). Since

MMC™ integrates a NAND flash memory and a controller chip in a single package, it can perform such controls as error corrections, wear leveling and bad-block management internally. All

MMC™ parts have compatible pin-layouts for all derivatives and generations. This frees users from the worry of control operations otherwise required for NAND flash memory, making it easy to use.

Product List of

MMC™

Product List of

MMC™

Support

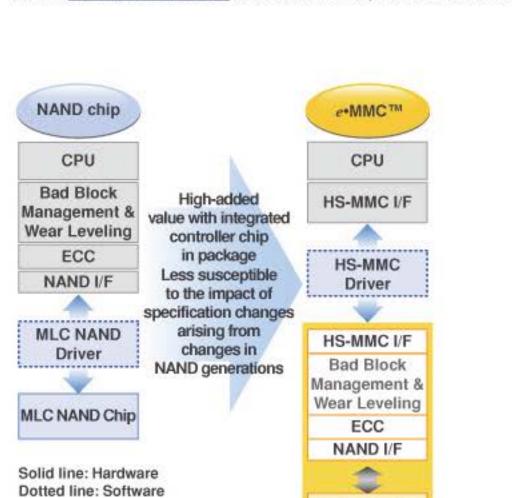
Capacity	Part Number	e-MMC Version	The contract of the contract o	Power Supply		Ou	
				Vcc (V)	VccQ (V)	Operating Temperature (°C)	Package
2 GByte	THGBM4G4D1HBAIR	4.41	to 52	2.7 to 3.6	1.65 to 1.95, 2.7 to 3.62	-25 to 85	P-VFBGA153-1113-0.50-002
4 GByte	THGBM5G5A1JBAIR*	4.41a	to 200		1.70 to 1.95, 2.7 to 3.6		
8 GByte	THGBM5G6A2JBAIR*	4.41a	to 200		1.70 to 1.95, 2.7 to 3.6		
16 GByte	THGBM5G7A2JBAIM*	4.41a	to 200		1.70 to 1.95, 2.7 to 3.6		P-VFBGA169-1216-0.50-001
32 Gbyte	THGBM5G8A4JBAIM*	4.41a	to 200				
64 Gbyte	THGBM5G9B8JBAIE*	4.41a	to 200		1.70 to 1.95, 2.7 to 3.6		P-TFBGA169-1216-0.50A4
128 Gbyte	THGBM4T0DBGBAIJ	4.41	to 52		1.65 to 1.95, 2.7 to 3.6		P-FBGA169-1418-0.50-001

Applications

*: New Product

Please contact Toshiba sales to check the latest product information and request technical datasheets.

MLC NAND Chip



e•MMC™ is the trademark of JEDEC/MMCA.

Back to Top

Back to Memory home

Memory

- Contact Memory sales in <u>Europe</u>
- News Releases
- Documents



